






SPECIFICATIONS

CUSTOMER : _____
MODEL NO. : **GFTO024KD240320**
VERSION : **C**
DATE : **2023.03.03**
CERTIFICATION : **ROHS**

Customer Sign	Approved By	Prepared By	Prepared By
			

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1.SPECIFICATIONS

1.1 Features

Main LCD Panel

Item	Standard Value
Display Type	240 * (R、G、B) * 320 Dots
LCD Type	a-Si TFT, Normally white TN mode, Transmissive
Screen size(Inch)	2.4 (Diagonal)
Gray Scale Inversion Direction	12 O'clock
Color configuration	R.G.B. vertical stripe
Interface	8080MCU, SPI, RGB interface
Other(controller / driver IC)	ILI9341

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	42.72 (W) * 60.26 (L) * 2.5(H)	mm
Active Area	36.72 (W) * 48.96 (L)	mm

Note : For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Logic Supply Voltage	IOVCC	-	-0.3	+4.6	V
Analog Supply Voltage	VCC	-	-0.3	+4.6	V
Input Voltage	VIN	-	-0.3	IOVCC+0.3	V
Operating Temperature	T _{OP}	Note 1	-20	+70	°C
Storage Temperature	T _{ST}	Note 2	-30	+80	°C
Storage Humidity	H _D	T _a ≤ 60 °C	10	90	%RH

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

Note 1 : T_s is the temperature of panel's surface.

Note 2 : T_a is the ambient temperature of samples.

1.4 DC Electrical Characteristics

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Power Supply Voltage ¹	VCC / IOVCC		-	3.0	-	V
Input High Voltage	V _{IH}		0.7* IOVCC		IOVCC	V
Input Low Voltage	V _{IL}		GND		0.3* IOVCC	V
Output High Voltage	V _{OH}	I _{OH} =-1.0 mA	0.8* IOVCC		IOVCC	V
Output Low Voltage	V _{OL}	I _{OL} =+1.0mA	GND		0.2* IOVCC	V
Supply Current	I _{CC}	VCC=IOVCC =3.3V		8	14	mA

Note1 : I_{CC} contains the current of the IOVCC & VCC



1.5 Optical Characteristics

TFT LCD Panel

VDD = 3.3V, Ta=25°C

Item	Symbol	Condition	Min.	Typ.	Max.	unit		
Response time	Tr + Tf	-	-	30	45	ms	Note2	
Viewing angle	Top	$\theta Y+$	CR \geq 10	-	60	-	Deg.	Note4
	Bottom	$\theta Y-$		-	60	-		
	Left	$\theta X-$		-	60	-		
	Right	$\theta X+$		-	60	-		
Contrast ratio	CR	-	500	600	-	-	Note3	
Color of CIE Coordinate (With B/L)	White	X	IF=40mA	0.23	0.28	0.33	-	Note1
		Y		0.25	0.30	0.35		
	Red	X		0.55	0.60	0.65		
		Y		0.29	0.34	0.39		
	Green	X		0.30	0.35	0.40		
		Y		0.55	0.60	0.65		
	Blue	X		0.10	0.15	0.20		
		Y		0.01	0.03	0.11		
Average Brightness Pattern = white display (With B/L)	IV	IF=40mA	-	320	-	cd/m ²	Note1	
Uniformity (With B/L)	ΔB	-	80	-	-	%	Note1	

Note1:

1 : $\Delta B = B(\min) / B(\max) \times 100\%$

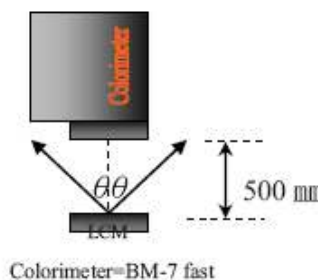
2 : Measurement Condition for Optical Characteristics:

a : Environment: 25°C \pm 5°C / 60 \pm 20% R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: 500 \pm 50 mm , ($\theta = 0^\circ$)

c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.

d : The uncertainty of the C.I.E coordinate measurement \pm 0.01 , Average Brightness \pm 4%

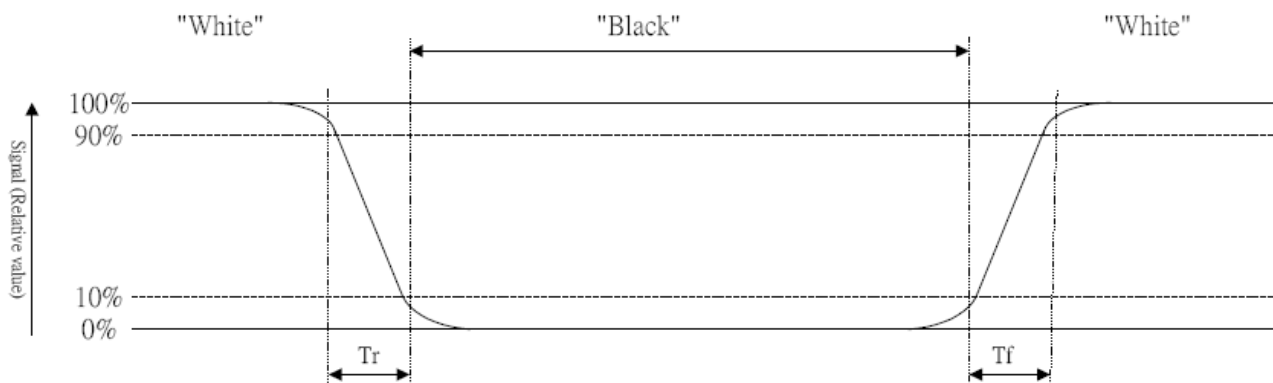




Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from "white" to "black"(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



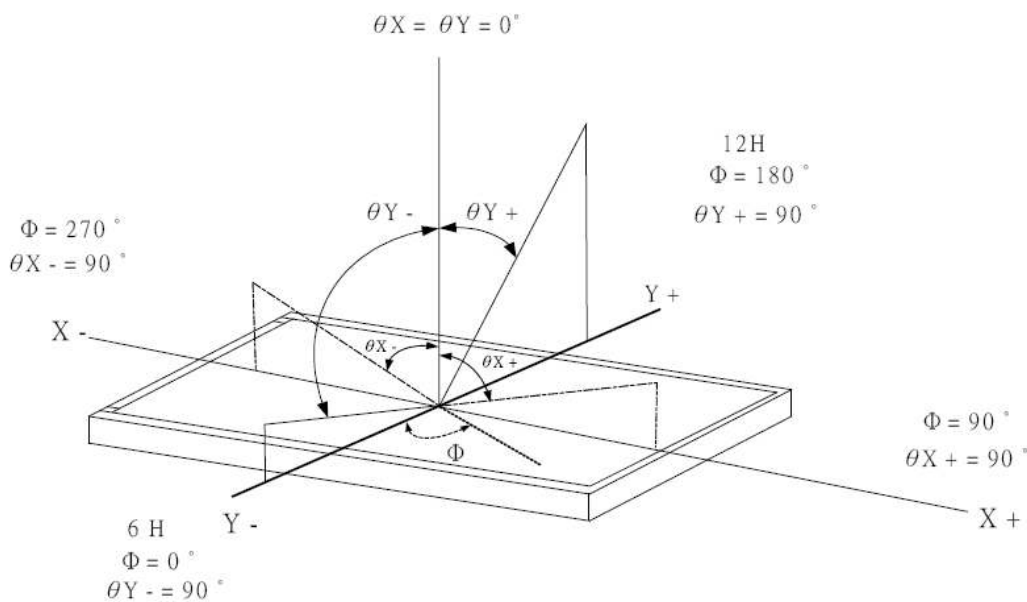
Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

$$\text{Contrast ratio (CR)} = \frac{\text{Photo detector output when LCD is at "White" state}}{\text{Photo detector output when LCD is at "Black" state}}$$

Note4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics

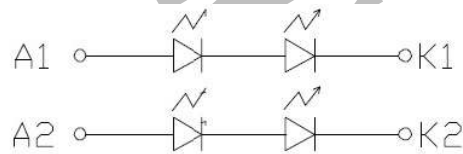
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°C	-	60	mA
Reverse Voltage	VR	Ta =25°C	-	7	V
Power dissipation	Pd	Ta =25°C	-	420	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF=40mA	5.6	6.7	7.0	V
Color of CIE Coordinate (without LCD & T/P)	X		0.25	0.28	0.31	-
	Y		0.25	0.28	0.31	
Color		White				

B/L Internal Circuit Diagram



$$IF=20mA*2, Vf=6.6V$$

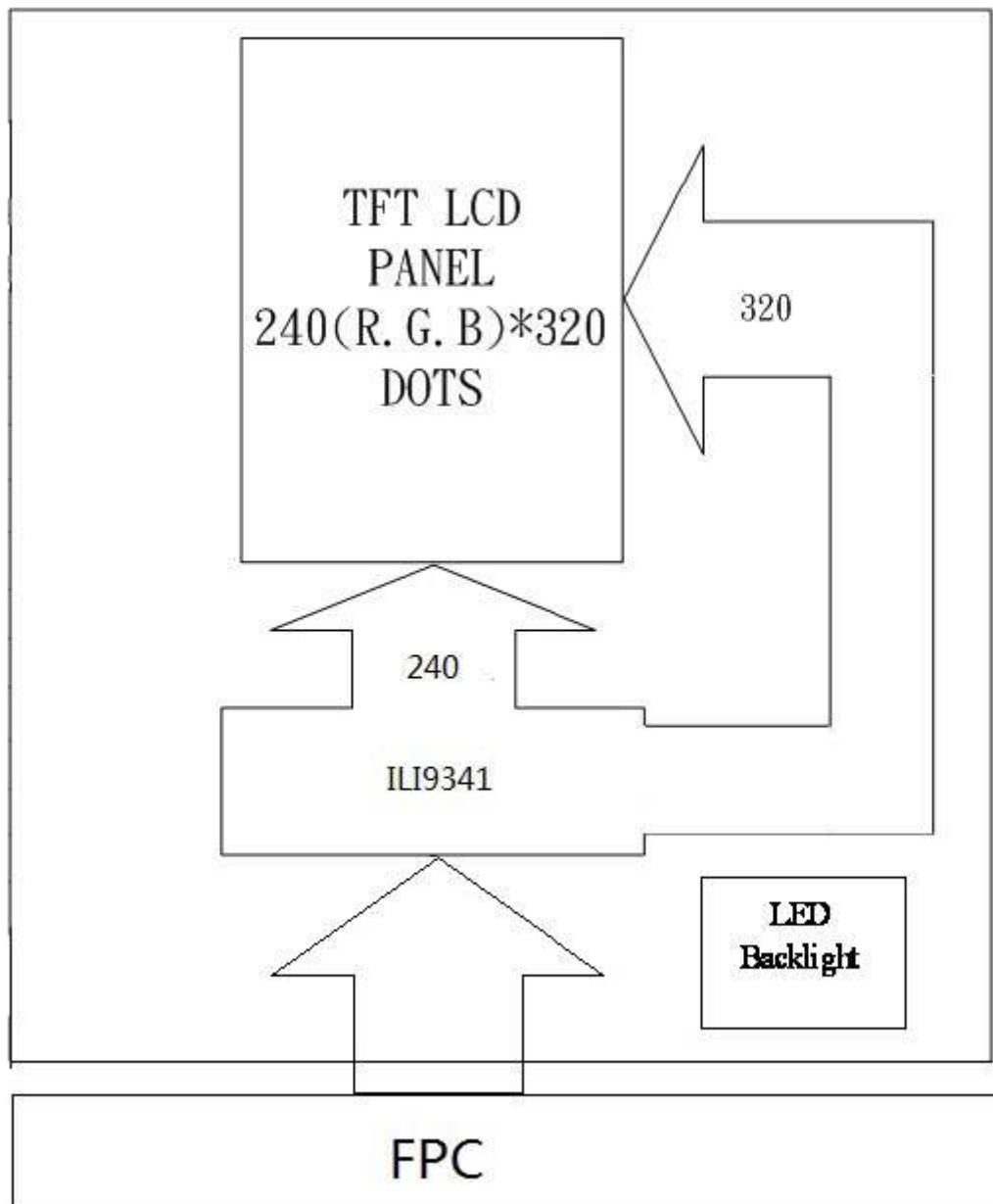
Other Description

Item	Conditions	Description
Life Time	Ta =25°C IF= 40mA	20000 hrs



2. MODULE STRUCTURE

2.1 Block Diagram





2.2 Interface Pin Description

Pin No.	Symbol	Function
1	VCI	System power supply.
2	IOVCC	I/O Power supply.
3	IM0	Note 1
4	IM1	
5	IM2	
6	IM3	
7	RESET	Reset signal input terminal, active at "L".
8	VSYNC	Vertical sync signal in RGB I/F.
9	HSYNC	Horizontal sync signal in RGB I/F.
10	DOTCLK	Pixel clock signal in RGB I/F.
11	ENABLE	Data Enable signal in RGB I/F mode
12	DB17	16-bit/pixel: D[17:13]=R[4:0], D[11:6]=G[5:0] and D[5:1]=B[4:0]; Connect D0 and D12 pins to GND.
13	DB16	
14	DB15	
15	DB14	
16	DB13	
17	DB12	
18	DB11	
19	DB10	
20	DB9	
21	DB8	
22	DB7	
23	DB6	
24	DB5	
25	DB4	
26	DB3	
27	DB2	
28	DB1	16-bit/pixel: D[17:13]=R[4:0], D[11:6]=G[5:0] and D[5:1]=B[4:0]; Connect D0 and D12 pins to GND.
29	DB0	
30	SDO	Serial output signal. The data is outputted on the falling edge of the SCL signal.
31	SDI	Serial data input signal in SPI I/F. If not used, open this pin.
32	RD	Read signal in 80-system.
33	WR	Write signal in 80-system.



34	RS/SCL	This pin is used to select "Data or Command" in the parallel interface When DCX = '1', data is selected. When DCX = '0', command is selected. This pin is used serial interface clock in 3-wire 9-bit / 4-wire 8-bit serial data interface.
35	CS(CSX)	Chip select input pin ("Low" enable). This pin can be permanently fixed "Low" in MPU interface mode only.
36	GND(VSS)	Power ground.
37	LEDA	LED backlight anode.
38	LEDK1	LED backlight cathode.
39	LEDK2	LED backlight cathode.
40	NC	No Function
41	NC	
42	NC	
43	NC	
44	NC	
45	NC	

Note1:

IM3	IM2	IM1	IM0	MCU-Interface Mode	DB Pin in use	
					Register/Content	GRAM
0	0	0	0	80 MCU 8-bit bus interface I	D[7:0]	D[7:0]
0	0	0	1	80 MCU 16-bit bus interface I	D[7:0]	D[15:0]
0	0	1	0	80 MCU 9-bit bus interface I	D[7:0]	D[8:0]
0	0	1	1	80 MCU 18-bit bus interface I	D[7:0]	D[17:0]
0	1	0	1	3-wire 9-bit data serial interface I	SDA: In/OUT	
0	1	1	0	4-wire 8-bit data serial interface I	SDA: In/OUT	
1	0	0	0	80 MCU 16-bit bus interface II	D[8:1]	D[17:10], D[8:1]
1	0	0	1	80 MCU 8-bit bus interface II	D[17:10]	D[17:10]
1	0	1	0	80 MCU 18-bit bus interface II	D[8:1]	D[17:0]
1	0	1	1	80 MCU 9-bit bus interface II	D[17:10]	D[17:9]
1	1	0	1	3-wire 9-bit data serial interface II	SDI: In SDO: Out	
1	1	1	0	4-wire 8-bit data serial interface II	SDI: In SDO: Out	



2.2.1 Application Notes:

```
void Initial_Main(void)
{
    WriteCOM_Main(0xCB)
    WriteDAT_Main(0x39)
    WriteDAT_Main(0x2C)
    WriteDAT_Main(0x00)
    WriteDAT_Main(0x34)
    WriteDAT_Main(0x02)
    WriteCOM_Main(0xCF)
    WriteDAT_Main(0x00)
    WriteDAT_Main(0xD9)
    WriteDAT_Main(0x30)
    WriteCOM_Main(0xE8)
    WriteDAT_Main(0x85)
    WriteDAT_Main(0x00)
    WriteDAT_Main(0x78)
    WriteCOM_Main(0xEA)
    WriteDAT_Main(0x00)
    WriteDAT_Main(0x00)
    WriteCOM_Main(0xED)
    WriteDAT_Main(0x64)
    WriteDAT_Main(0x03)
    WriteDAT_Main(0x12)
    WriteDAT_Main(0x81)
    WriteCOM_Main(0xF6)
    WriteDAT_Main(0x01)
    WriteDAT_Main(0x00)
    WriteDAT_Main(0x06)
    WriteCOM_Main(0xB0)
    WriteDAT_Main(0x40)
    WriteCOM_Main(0x3A)
    WriteDAT_Main(0x55)
    WriteCOM_Main(0xF7)
    WriteDAT_Main(0x20)
    WriteCOM_Main(0xC0)
    WriteDAT_Main(0x21)
    WriteCOM_Main(0xC1)
    WriteDAT_Main(0x12)
```



```
WriteCOM_Main(0xC5)
WriteDAT_Main(0x32)
WriteDAT_Main(0x3C)
WriteCOM_Main(0xC7)
WriteDAT_Main(0xA3)
WriteCOM_Main(0x36)
WriteDAT_Main(0x00)
WriteCOM_Main(0xB0)
WriteDAT_Main(0x40)
WriteCOM_Main(0xB1)
WriteDAT_Main(0x00)
WriteDAT_Main(0x1B)
WriteCOM_Main(0xB6)
WriteDAT_Main(0x0a)
WriteDAT_Main(0xa2)
WriteDAT_Main(0x27)
WriteDAT_Main(0x00)
WriteCOM_Main(0xF2)
WriteDAT_Main(0x00)
WriteCOM_Main(0x26)
WriteDAT_Main(0x01)
WriteCOM_Main(0xe0) //set gamma
WriteDAT_Main(0x0F)
WriteDAT_Main(0x1C)
WriteDAT_Main(0x19)
WriteDAT_Main(0x08)
WriteDAT_Main(0x0B)
WriteDAT_Main(0x04)
WriteDAT_Main(0x4B)
WriteDAT_Main(0x64)
WriteDAT_Main(0x3E)
WriteDAT_Main(0x09)
WriteDAT_Main(0x15)
WriteDAT_Main(0x08)
WriteDAT_Main(0x16)
WriteDAT_Main(0x0D)
WriteDAT_Main(0x04)
WriteCOM_Main(0xe1) //set gamma
WriteDAT_Main(0x00)
```



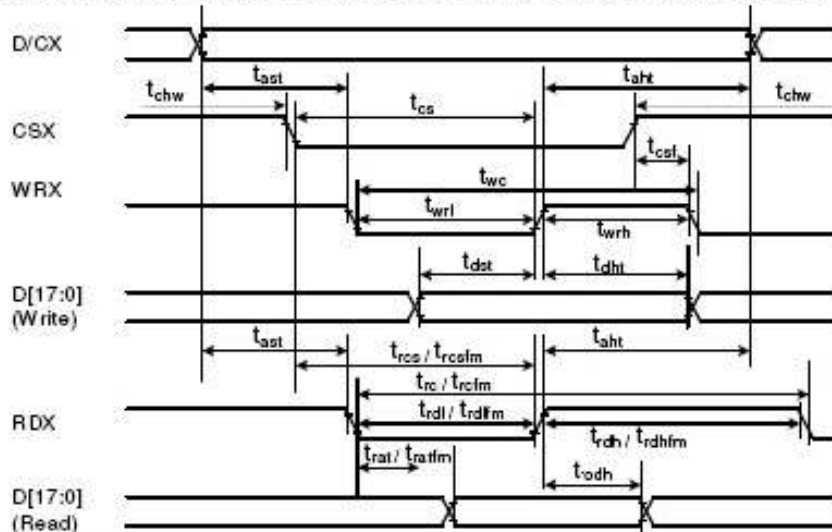
```
WriteDAT_Main(0x1A)
WriteDAT_Main(0x1E)
WriteDAT_Main(0x03)
WriteDAT_Main(0x0F)
WriteDAT_Main(0x03)
WriteDAT_Main(0x35)
WriteDAT_Main(0x23)
WriteDAT_Main(0x45)
WriteDAT_Main(0x04)
WriteDAT_Main(0x0C)
WriteDAT_Main(0x0B)
WriteDAT_Main(0x2B)
WriteDAT_Main(0x2E)
WriteDAT_Main(0x05)
WriteCOM_Main(0x11)           //exit sleep
Delay(120)
WriteCOM_Main(0x29)         //Display on
}
```

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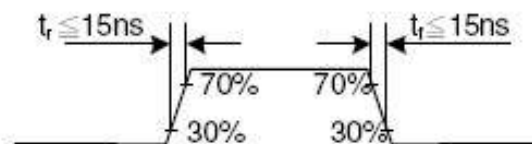
2.3 Timing Characteristics

Display Parallel 18/16/9/8-bit Interface Timing Characteristics (8080- I system)



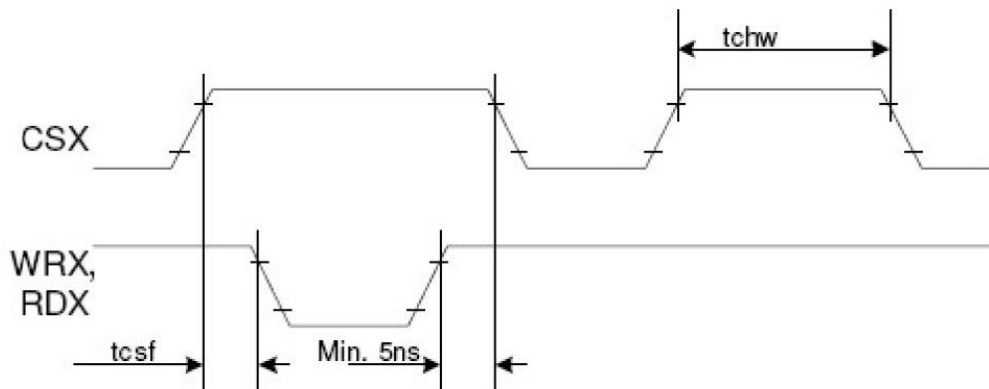
Signal	Symbol	Parameter	min	max	Unit	Description
DCX	t _{ast}	Address setup time	0	-	ns	
	t _{ah}	Address hold time (Write/Read)	0	-	ns	
CSX	t _{chw}	CSX "H" pulse width	0	-	ns	
	t _{cs}	Chip Select setup time (Write)	15	-	ns	
	t _{rcs}	Chip Select setup time (Read ID)	45	-	ns	
	t _{rcsfm}	Chip Select setup time (Read FM)	355	-	ns	
	t _{csf}	Chip Select Wait time (Write/Read)	10	-	ns	
WRX	t _{wc}	Write cycle	66	-	ns	
	t _{wrh}	Write Control pulse H duration	15	-	ns	
	t _{wrl}	Write Control pulse L duration	15	-	ns	
RDX (FM)	t _{rcfm}	Read Cycle (FM)	450	-	ns	
	t _{rdhfm}	Read Control H duration (FM)	90	-	ns	
	t _{rdlfm}	Read Control L duration (FM)	355	-	ns	
RDX (ID)	t _{rc}	Read cycle (ID)	160	-	ns	
	t _{rdh}	Read Control pulse H duration	90	-	ns	
	t _{rdl}	Read Control pulse L duration	45	-	ns	
D[17:0], D[15:0], D[8:0], D[7:0]	t _{dst}	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	t _{dht}	Write data hold time	10	-	ns	
	t _{rat}	Read access time	-	40	ns	
	t _{ratfm}	Read access time	-	340	ns	
	t _{rod}	Read output disable time	20	80	ns	

Note: Ta = -30 to 70 °C, VDD= 1.65V to 3.3V, VCI=2.5V to 3.3V, VSS=0V



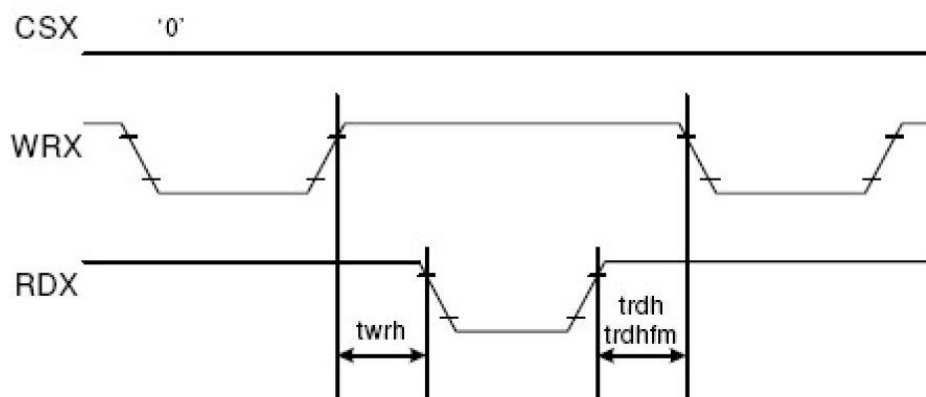


CSX timings :



Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Write to read or read to write timings:

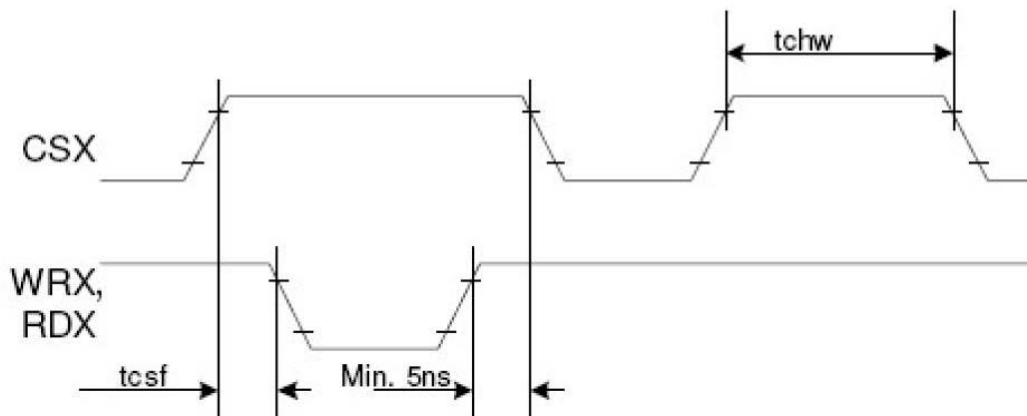


Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

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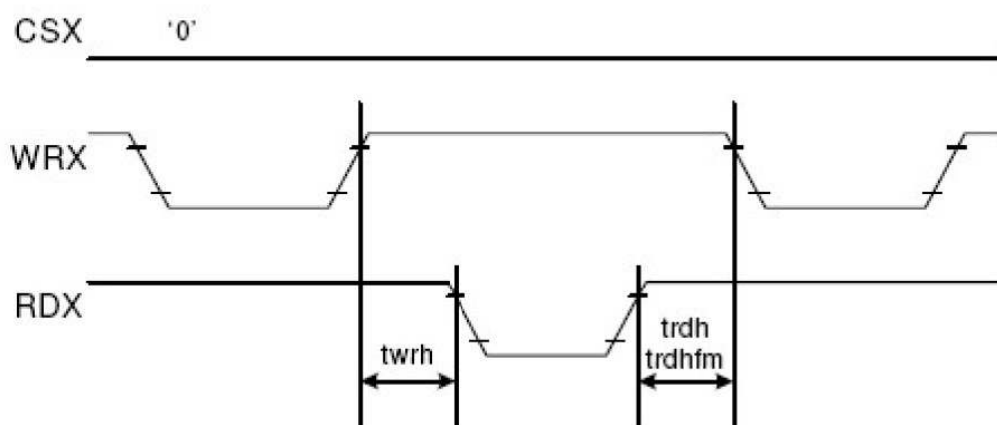


CSX timings :



Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Write to read or read to write timings:

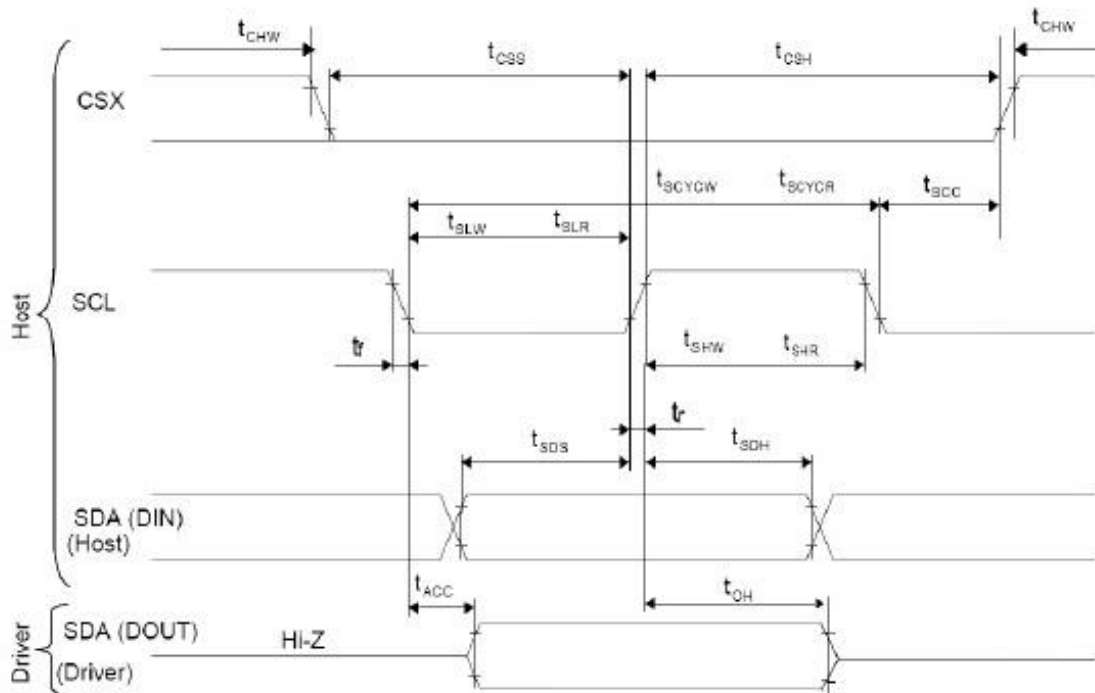


Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

400Y

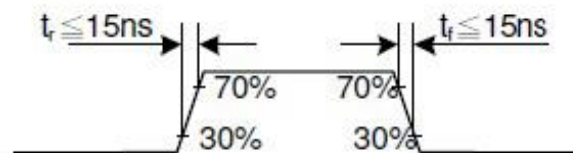


Display Serial Interface Timing Characteristics (3-line SPI system)



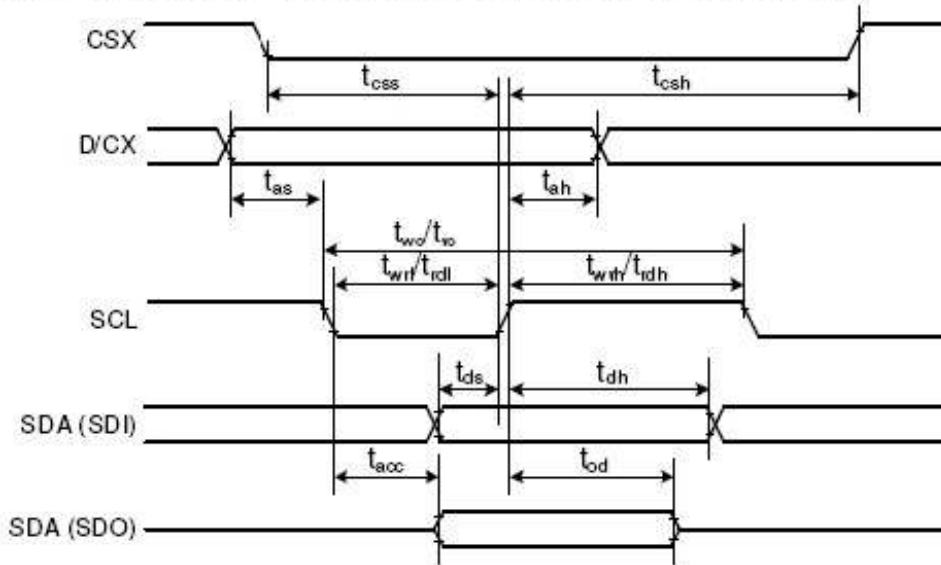
Signal	Symbol	Parameter	min	max	Unit	Description
SCL	tscycw	Serial Clock Cycle (Write)	100	-	ns	
	tshw	SCL "H" Pulse Width (Write)	40	-	ns	
	tslw	SCL "L" Pulse Width (Write)	40	-	ns	
	tscycr	Serial Clock Cycle (Read)	150	-	ns	
	tshr	SCL "H" Pulse Width (Read)	60	-	ns	
	tslr	SCL "L" Pulse Width (Read)	60	-	ns	
SDA / SDI (Input)	tsds	Data setup time (Write)	30	-	ns	
	tsdh	Data hold time (Write)	30	-	ns	
SDA / SDO (Output)	tacc	Access time (Read)	10	-	ns	
	toh	Output disable time (Read)	10	50	ns	
CSX	tscc	SCL-CSX	20	-	ns	
	tchw	CSX "H" Pulse Width	40	-	ns	
	tcss	CSX-SCL Time	60	-	ns	
	tcsh		65	-	ns	

Note: Ta = 25 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, VSS=0V



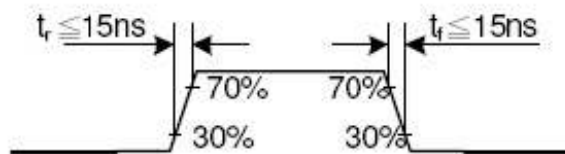


Display Serial Interface Timing Characteristics (4-line SPI system)



Signal	Symbol	Parameter	min	max	Unit	Description
CSX	t_{css}	Chip select time (Write)	40	-	ns	
	t_{csh}	Chip select hold time (Read)	40	-	ns	
SCL	t_{wc}	Serial clock cycle (Write)	100	-	ns	
	t_{wrh}	SCL "H" pulse width (Write)	40	-	ns	
	t_{wrl}	SCL "L" pulse width (Write)	40	-	ns	
	t_{rc}	Serial clock cycle (Read)	150	-	ns	
	t_{rdh}	SCL "H" pulse width (Read)	60	-	ns	
	t_{rdl}	SCL "L" pulse width (Read)	60	-	ns	
D/CX	t_{as}	D/CX setup time	10	-		
	t_{ah}	D/CX hold time (Write / Read)	10	-		
SDA / SDI (Input)	t_{ds}	Data setup time (Write)	30	-	ns	
	t_{dh}	Data hold time (Write)	30	-	ns	
SDA / SDO (Output)	t_{acc}	Access time (Read)	10	-	ns	For maximum $C_L=30pF$
	t_{od}	Output disable time (Read)	10	50	ns	For minimum $C_L=8pF$

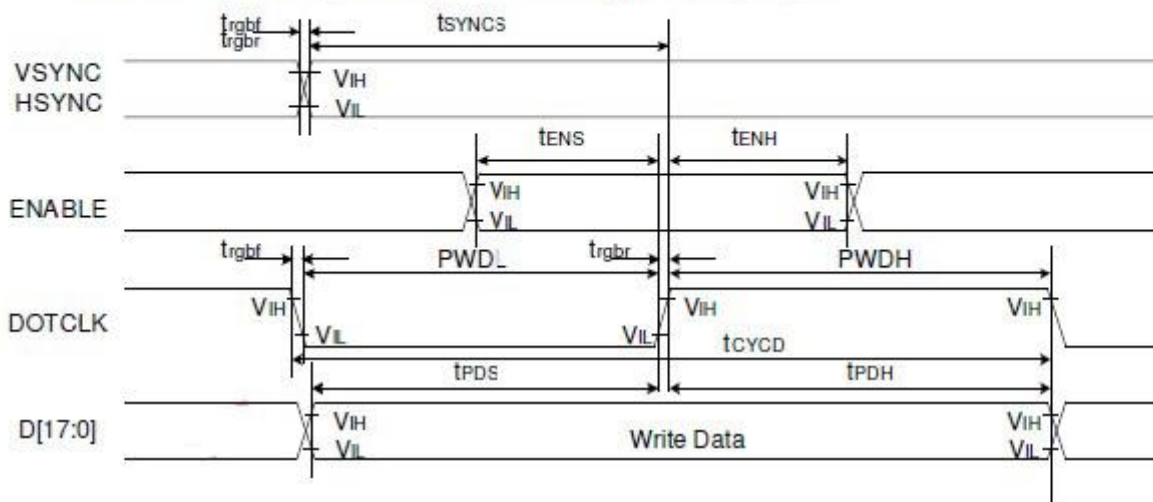
Note: $T_a = 25^\circ C$, $V_{DDI}=1.65V$ to $3.3V$, $V_{CI}=2.5V$ to $3.3V$, $V_{SS}=0V$



FOOT

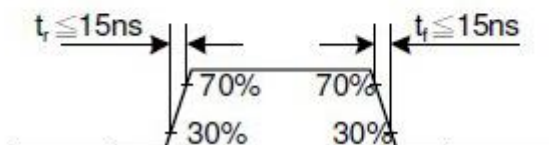


Parallel 18/16/6-bit RGB Interface Timing Characteristics



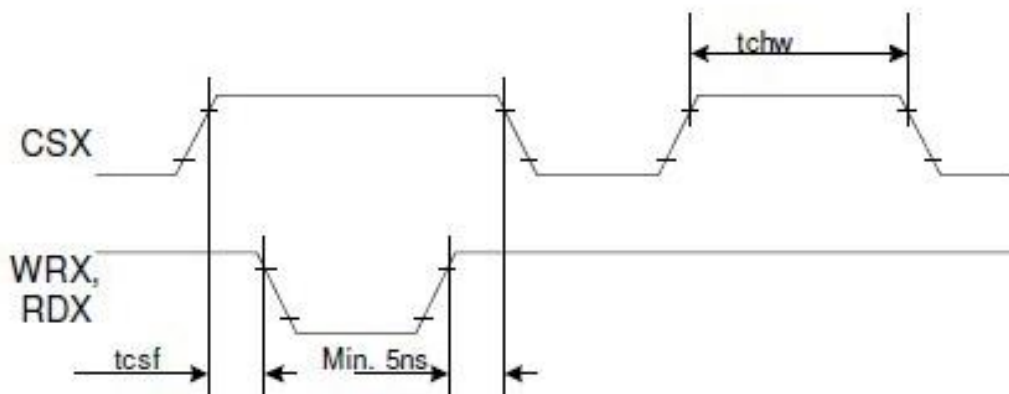
Signal	Symbol	Parameter	min	max	Unit	Description	
VSYNC / HSYNC	t _{synCS}	VSYNC/HSYNC setup time	15	-	ns	18/16-bit bus RGB interface mode	
	t _{synCH}	VSYNC/HSYNC hold time	15	-	ns		
DE	t _{ENS}	DE setup time	15	-	ns		
	t _{ENH}	DE hold time	15	-	ns		
D[17:0]	t _{POS}	Data setup time	15	-	ns		
	t _{PDH}	Data hold time	15	-	ns		
DOTCLK	PWD _H	DOTCLK high-level period	15	-	ns		
	PWD _L	DOTCLK low-level period	15	-	ns		
	t _{CYCD}	DOTCLK cycle time	100	-	ns		
	t _{trgbf} , t _{trgbr}	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns		
VSYNC / HSYNC	t _{synCS}	VSYNC/HSYNC setup time	15	-	ns		6-bit bus RGB interface mode
	t _{synCH}	VSYNC/HSYNC hold time	15	-	ns		
DE	t _{ENS}	DE setup time	15	-	ns		
	t _{ENH}	DE hold time	15	-	ns		
D[17:0]	t _{POS}	Data setup time	15	-	ns		
	t _{PDH}	Data hold time	15	-	ns		
DOTCLK	PWD _H	DOTCLK high-level pulse period	15	-	ns		
	PWD _L	DOTCLK low-level pulse period	15	-	ns		
	t _{CYCD}	DOTCLK cycle time	100	-	ns		
	t _{trgbf} , t _{trgbr}	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns		

Note: Ta = -30 to 70 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, VSS=0V



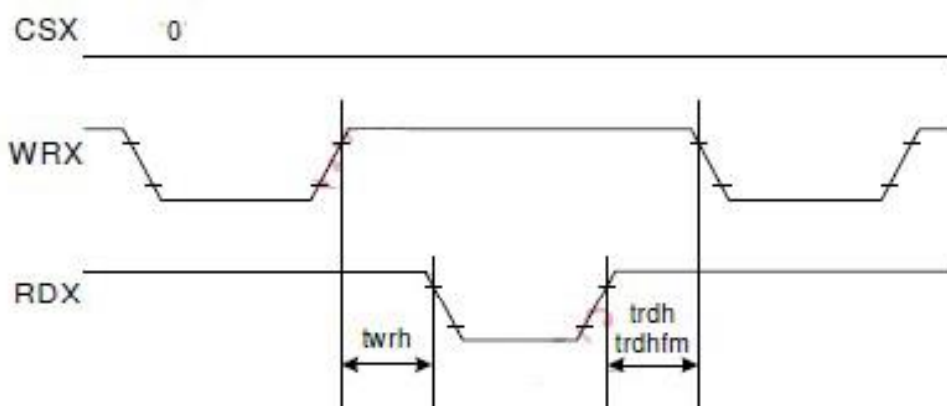


CSX timings :



Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Write to read or read to write timings:

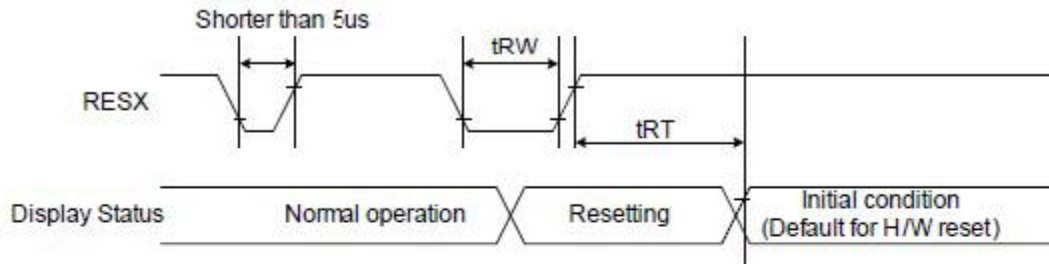


Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

400Y



Reset Timing



Signal	Symbol	Parameter	Min	Max	Unit
RESX	tRW	Reset pulse duration	10		uS
	tRT	Reset cancel		5 (note 1,5)	mS
				120 (note 1,6,7)	mS

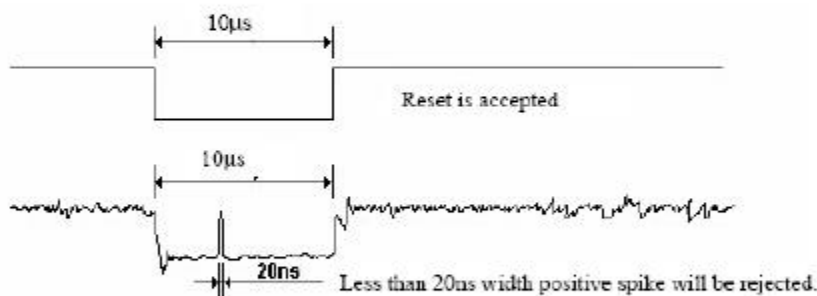
Note 1: The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NV memory to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.

Note 2: Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below: -

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 10us	Reset
Between 5us and 10us	Reset starts

Note 3: During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) And then return to Default condition for Hardware Reset.

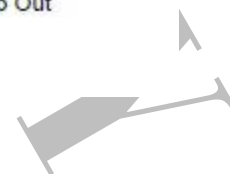
Note 4: Spike Rejection also applies during a valid reset pulse as shown below:



Note 5: When Reset applied during Sleep In Mode.

Note 6: When Reset applied during Sleep Out Mode.

Note 7: It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.



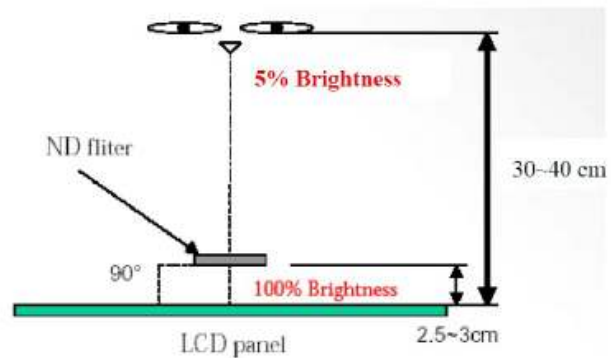
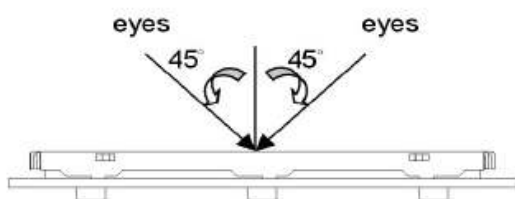


3. Inspection Specification

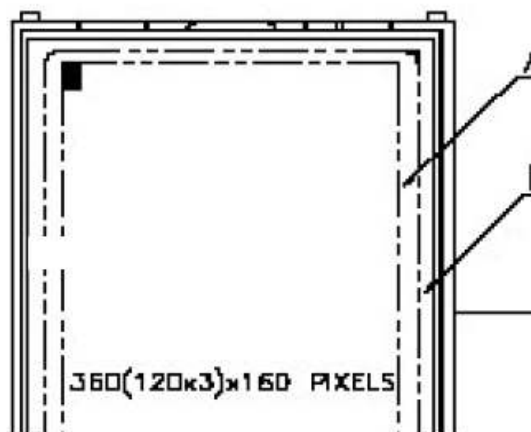
- ◆ Scope : The document shall be applied to TFT-LCD Module for less than 3.5" (Ver.B01).
- ◆ Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level II.
- ◆ Equipment : Gauge、MIL-STD、Tester、Sample
- ◆ Defect Level : Major Defect AQL : 0.4 ; Minor Defect AQL : 1.5
- ◆ OUT Going Defect Level: Sampling.
- ◆ Standard of the product appearance test :

a. Manner of appearance test :

- (1). The test best be under 20W×2 fluorescent light (about 300lux ~500lux)
 , and distance of view must be at 30~40 cm.
- (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area : viewing area

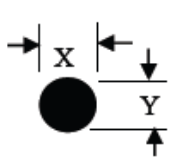
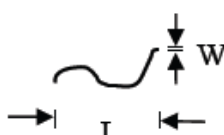
B area : Outside of viewing area

(4). Standard of inspection : (Unit : mm)



◆ Specification For TFT-LCD Module Less Than 3.5" :

(Ver.B01)

NO	Item	Criterion	Level																																												
06	<p>Black or white dot、scratch、contamination</p> <p>Round type</p>  <p>$\Phi = (x + y) / 2$</p> <p>Line type</p> 	<p>6. 1 Round type (Non-display or display) :</p> <table border="1"> <thead> <tr> <th rowspan="2">Dimension (diameter : Φ)</th> <th colspan="2">Acceptance (Q'ty)</th> </tr> <tr> <th>A area</th> <th>B area</th> </tr> </thead> <tbody> <tr> <td>$\Phi \leq 0.15$</td> <td colspan="2">Ignore</td> </tr> <tr> <td>$0.15 < \Phi \leq 0.20$</td> <td colspan="2">2</td> </tr> <tr> <td>$0.20 < \Phi \leq 0.30$</td> <td colspan="2">2</td> </tr> <tr> <td>$\Phi > 0.30$</td> <td colspan="2">0</td> </tr> <tr> <td>Total</td> <td colspan="2">3</td> </tr> </tbody> </table> <p>6. 2 Line type(Non-display or display) :</p> <table border="1"> <thead> <tr> <th colspan="2">Dimension</th> <th colspan="2">Acceptance (Q'ty)</th> </tr> <tr> <th>Length (L)</th> <th>Width (W)</th> <th>A area</th> <th>B area</th> </tr> </thead> <tbody> <tr> <td>---</td> <td>$W \leq 0.03$</td> <td colspan="2">Ignore</td> </tr> <tr> <td>$L \leq 5.0$</td> <td>$0.03 < W \leq 0.05$</td> <td colspan="2">3</td> </tr> <tr> <td>---</td> <td>$W > 0.05$</td> <td colspan="2">As round type</td> </tr> <tr> <td colspan="2">Total</td> <td colspan="2">3</td> </tr> </tbody> </table>	Dimension (diameter : Φ)	Acceptance (Q'ty)		A area	B area	$\Phi \leq 0.15$	Ignore		$0.15 < \Phi \leq 0.20$	2		$0.20 < \Phi \leq 0.30$	2		$\Phi > 0.30$	0		Total	3		Dimension		Acceptance (Q'ty)		Length (L)	Width (W)	A area	B area	---	$W \leq 0.03$	Ignore		$L \leq 5.0$	$0.03 < W \leq 0.05$	3		---	$W > 0.05$	As round type		Total		3		Minor
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07	Polarizer Bubble	<table border="1"> <thead> <tr> <th rowspan="2">Dimension (diameter : Φ)</th> <th colspan="2">Acceptance (Q'ty)</th> </tr> <tr> <th>A area</th> <th>B area</th> </tr> </thead> <tbody> <tr> <td>$\Phi \leq 0.20$</td> <td colspan="2">Ignore</td> </tr> <tr> <td>$0.20 < \Phi \leq 0.50$</td> <td colspan="2">3</td> </tr> <tr> <td>$\Phi > 0.50$</td> <td colspan="2">0</td> </tr> <tr> <td>Total</td> <td colspan="2">3</td> </tr> </tbody> </table>	Dimension (diameter : Φ)	Acceptance (Q'ty)		A area	B area	$\Phi \leq 0.20$	Ignore		$0.20 < \Phi \leq 0.50$	3		$\Phi > 0.50$	0		Total	3		Minor																											
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◆ Specification For TFT-LCD Module Less Than 3.5" :

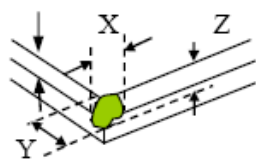
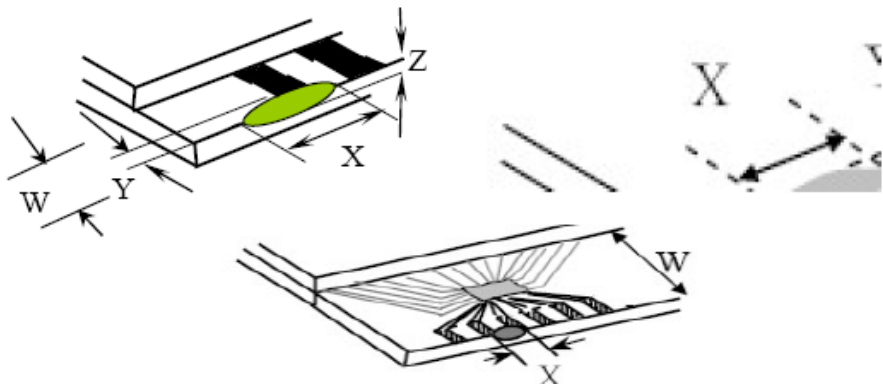
(Ver.B01)

NO	Item	Criterion	Level						
08	The crack of glass	Symbols : X : The length of crack Z : The thickness of crack t : The thickness of glass Y : The width of crack. W : terminal length a : LCD side length	Minor						
		<p>8.1 General glass chip :</p> <p>8.1.1 Chip on panel surface and crack between panels:</p> <div data-bbox="558 784 1356 1478" style="text-align: center;"> </div> <table border="1" data-bbox="534 1518 1364 1818" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>$\leq a$</td> <td>Crack can't enter viewing area</td> <td>$\leq 1/2 t$</td> </tr> <tr> <td>$\leq a$</td> <td>Crack can't exceed the half of SP width.</td> <td>$1/2 t < Z \leq 2 t$</td> </tr> </tbody> </table>		X	Y	Z	$\leq a$	Crack can't enter viewing area	$\leq 1/2 t$
X	Y	Z							
$\leq a$	Crack can't enter viewing area	$\leq 1/2 t$							
$\leq a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$							



◆Specification For TFT-LCD Module Less Than 3.5" :

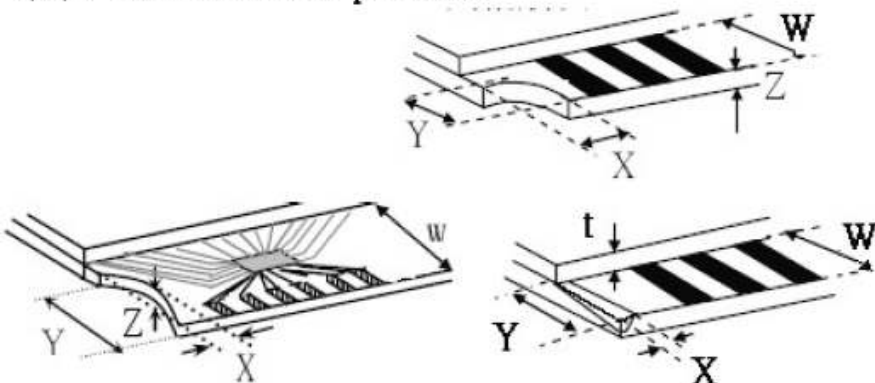
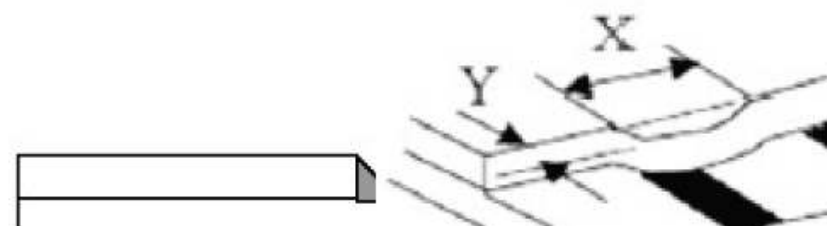
(Ver.B01)

NO	Item	Criterion	Level									
08	The crack of glass	<p>Symbols :</p> <p>X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length</p> <hr/> <p>8.1.2 Corner crack :</p>  <table border="1" style="width: 100%; text-align: center;"> <thead> <tr> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>$\leq 1/5 a$</td> <td>Crack can't enter viewing area</td> <td>$Z \leq 1/2 t$</td> </tr> <tr> <td>$\leq 1/5 a$</td> <td>Crack can't exceed the half of SP width.</td> <td>$1/2 t < Z \leq 2 t$</td> </tr> </tbody> </table>	X	Y	Z	$\leq 1/5 a$	Crack can't enter viewing area	$Z \leq 1/2 t$	$\leq 1/5 a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$	Minor
		X	Y	Z								
$\leq 1/5 a$	Crack can't enter viewing area	$Z \leq 1/2 t$										
$\leq 1/5 a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$										
<p>8.2 Protrusion over terminal :</p> <p>8.2.1 Chip on electrode pad :</p>  <table border="1" style="width: 100%; text-align: center;"> <thead> <tr> <th></th> <th>X</th> <th>Y</th> <th>Z</th> </tr> </thead> <tbody> <tr> <td>Front</td> <td>$\leq a$</td> <td>$\leq 1/2 W$</td> <td>$\leq t$</td> </tr> <tr> <td>Back</td> <td>$\leq a$</td> <td>$\leq W$</td> <td>$\leq 1/2 t$</td> </tr> </tbody> </table>		X	Y	Z	Front	$\leq a$	$\leq 1/2 W$	$\leq t$	Back	$\leq a$	$\leq W$	$\leq 1/2 t$
	X	Y	Z									
Front	$\leq a$	$\leq 1/2 W$	$\leq t$									
Back	$\leq a$	$\leq W$	$\leq 1/2 t$									



◆ Specification For TFT-LCD Module Less Than 3.5" :

(Ver.B01)

NO	Item	Criterion	Level												
08	The crack of glass	<p>Symbols :</p> <p>X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length</p> <hr/> <p>8.2.2 Non-conductive portion :</p>  <table border="1" data-bbox="606 996 1252 1153" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th style="text-align: center;">X</th> <th style="text-align: center;">Y</th> <th style="text-align: center;">Z</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">$\leq 1/3 a$</td> <td style="text-align: center;">$\leq W$</td> <td style="text-align: center;">$\leq t$</td> </tr> </tbody> </table> <p>⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.</p> <p>8.2.3 Glass remain :</p>  <table border="1" data-bbox="526 1814 1236 1937" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th style="text-align: center;">X</th> <th style="text-align: center;">Y</th> <th style="text-align: center;">Z</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">$\leq a$</td> <td style="text-align: center;">$\leq 1/3 W$</td> <td style="text-align: center;">$\leq t$</td> </tr> </tbody> </table>	X	Y	Z	$\leq 1/3 a$	$\leq W$	$\leq t$	X	Y	Z	$\leq a$	$\leq 1/3 W$	$\leq t$	Minor
X	Y	Z													
$\leq 1/3 a$	$\leq W$	$\leq t$													
X	Y	Z													
$\leq a$	$\leq 1/3 W$	$\leq t$													



◆Specification For TFT-LCD Module Less Than 3.5" :

(Ver.B01)

NO	Item	Criterion	Level
09	Backlight elements	9.1 Backlight can't work normally.	Major
		9.2 Backlight doesn't light or color is wrong.	Major
		9.3 Illumination source flickers when lit.	Major
10	General appearance	10.1 Pin type 、 quantity 、 dimension must match type in structure diagram.	Major
		10.2 No short circuits in components on PCB or FPC.	Major
		10.3 Parts on PCB or FPC must be: no wrong parts, missing parts or excess parts.	Major
		10.4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
		10.6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤ 1.5 mm.	Minor

SECRET



4. RELIABILITY TEST

NO.	ITEM	CONDITION		STANDARD	NOTE
1	High Temp. Storage	80°C	120 hrs	Appearance Without defect	
2	Low Temp. Storage	-30°C	120 hrs	Appearance Without defect	
3	High Temp. & High Humi. Storage	40°C 90% RH	120 hrs	Appearance Without defect	
4	High Temp. Operating Display	70°C	120 hrs	Appearance Without defect	
5	Low Temp. Operating Display	-20°C	120 hrs	Appearance Without defect	
6	Thermal Shock	-20°C, 30min. → 70°C, 30min. ↑ (1cycle)		Appearance Without defect	10 cycles

** Dissipation current, contrast and display functions

** Polarizing filter deterioration, other appearance defects

** The function test shall be conducted after 4hours storage at the normal temperature and humidity after remove from the test chamber.



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.

5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

5.2.1 Avoid any strong mechanical shock which can break the glass.

5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.

5.2.3 Do not remove the panel or frame from the module.

5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)

5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.

5.2.6 Do not touch the display area with bare hands , this will stain the display area.

5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.2.8 To control temperature and time of soldering is $320 \pm 5^{\circ}\text{C}$ and 3-5 sec.

5.2.9 To avoid liquid (include organic solvent) stained on LCM

5.3 STORAGE

5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ and the humidity is below 65% RH.

5.3.2 Do not place the module near organics solvents or corrosive gases.

5.3.3 Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

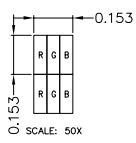
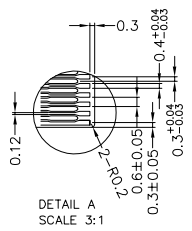
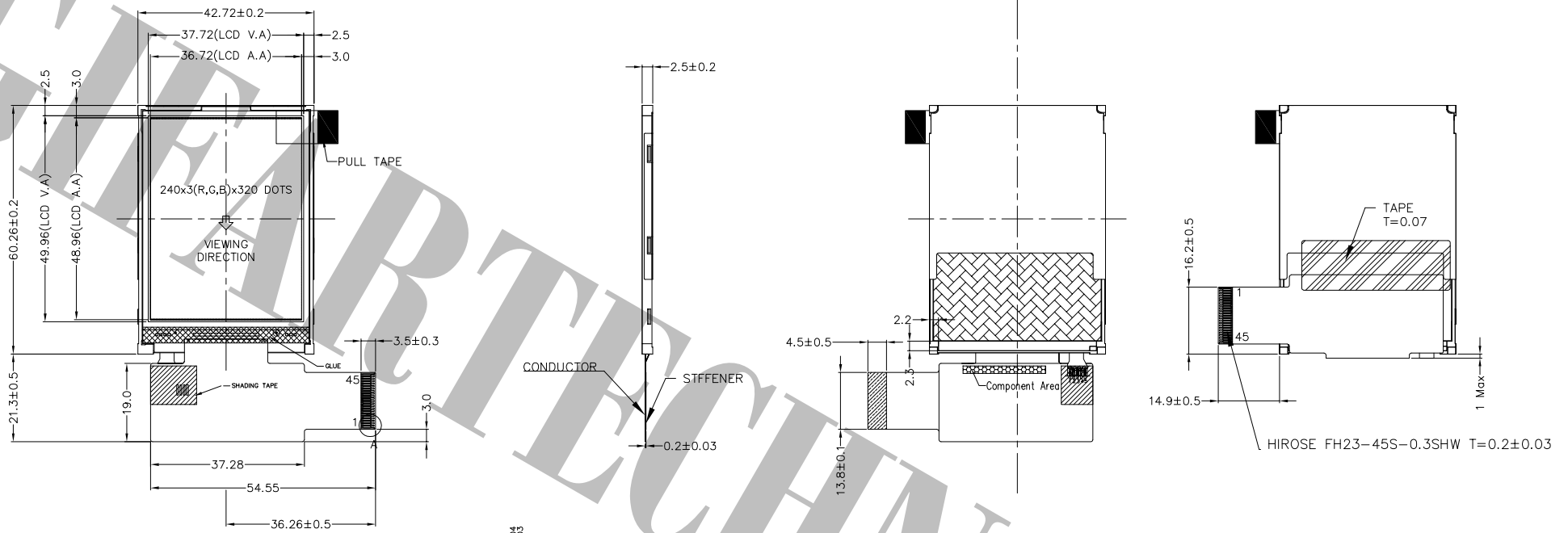
5.4.1 Applicable warrant period

The period is within one year since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

6. Appendix



- NOTES:
- 1.) LCD TYPE: a-Si TFT
 - 2.) LCD DISPLAY: POSITIVE/TRANSMISSIVE
 - 3.) Gray Scale Inversion View Direction: 12 O'CLOCK
Eyes View Direction: 6 O'CLOCK
 - 4.) THE TOLERANCE UNLESS CLASSIFIED $\pm 0.3\text{mm}$
THE R FOR NOT ASSIGNED $0.5 \pm 0.1\text{mm}$
 - 5.) COMPONENT AREA HEIGHT 1.0 MAX.

日期	版本	修改内容	晶發科技股份有限公司 GI FAR TECHNOLOGY CO., LTD					
			DATE	2020.10.21	REV	00	DRAWING NO. : 4M-2020092201	
			UNIT : mm	Product : GFTO024KD240320				
			SCALE : 1/1	DRAWN:	Hazel	CHECKED:		Sidney